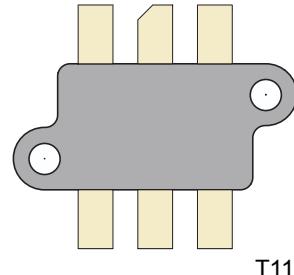


## RF POWER VERTICAL MOSFET

The VRF191 is a gold-metallized silicon n-channel RF power transistor designed for broadband commercial and military applications requiring high power and gain without compromising reliability, ruggedness, or inter-modulation distortion.



T11

### FEATURES

- Improved Ruggedness  $V_{(BR)DSS} = 270V$  min
- 150W with 22dB Typical Gain @ 30MHz, 100V
- 150W with 14dB Typical Gain @ 150MHz, 100V
- Excellent Stability & Low IMD
- Common Source Configuration
- RoHS Compliant 
- 5:1 Load VSWR Capability at Specified Operating Conditions
- Nitride Passivated
- Refractory Gold Metallization
- High Performance Flangeless Package

### Maximum Ratings

 All Ratings:  $T_c = 25^\circ\text{C}$  unless otherwise specified

Symbol	Parameter	VRF191	Unit
$V_{DSS}$	Drain-Source Voltage	270	V
$I_D$	Continuous Drain Current @ $T_c = 25^\circ\text{C}$	12	A
$V_{GS}$	Gate-Source Voltage	$\pm 40$	V
$P_D$	Total Device dissipation @ $T_c = 25^\circ\text{C}$	300	W
$T_{STG}$	Storage Temperature Range	-65 to 200	$^\circ\text{C}$
$T_J$	Operating Junction Temperature	200	

### Static Electrical Characteristics

Symbol	Parameter	Min	Typ	Max	Unit
$V_{(BR)DSS}$	Drain-Source Breakdown Voltage ( $V_{GS} = 0V$ , $I_D = 100\text{mA}$ )	270	280		V
$V_{DS(ON)}$	On State Drain Voltage ( $I_{D(ON)} = 5\text{A}$ , $V_{GS} = 10\text{V}$ )		3.5	5.0	
$I_{DSS}$	Zero Gate Voltage Drain Current ( $V_{DS} = 200\text{V}$ , $V_{GS} = 0\text{V}$ )			1.0	mA
$I_{GSS}$	Gate-Source Leakage Current ( $V_{DS} = \pm 20\text{V}$ , $V_{GS} = 0\text{V}$ )			1.0	$\mu\text{A}$
$g_{fs}$	Forward Transconductance ( $V_{DS} = 10\text{V}$ , $I_D = 5\text{A}$ )	4.0	6		mhos
$V_{GS(TH)}$	Gate Threshold Voltage ( $V_{DS} = 10\text{V}$ , $I_D = 100\text{mA}$ )	2.9	3.6	4.4	V

### Thermal Characteristics

Symbol	Characteristic	Min	Typ	Max	Unit
$R_{\theta JC}$	Junction to Case Thermal Resistance			0.35	
$R_{\theta JS}$	Junction to Sink (Use high efficiency thermal joint compound and planar heat sink surface.)		.45		$^\circ\text{C/W}$

 CAUTION: These Devices are Sensitive to Electrostatic Discharge. Proper Handling Procedures Should Be Followed.

## Dynamic Characteristics

VRF191

Symbol	Parameter	Test Conditions	Min	Typ	Max	Unit
$C_{iss}$	Input Capacitance	$V_{GS} = 0V$ $V_{DS} = 100V$ $f = 1MHz$		460		pF
$C_{oss}$	Output Capacitance			80		
$C_{rss}$	Reverse Transfer Capacitance			6		

## Functional Characteristics

Symbol	Parameter	Min	Typ	Max	Unit
$G_{PS}$	$f_1 = 30MHz, V_{DD} = 100V, I_{DQ} = 250mA, P_{out} = 150W$	18	22		dB
$G_{PS}$	$f_1 = 150MHz, V_{DD} = 100V, I_{DQ} = 250mA, P_{out} = 150W$		14		
$\eta_D$	$f_1 = 30MHz, V_{DD} = 100V, I_{DQ} = 250mA, P_{out} = 150W$		50		%
$\psi$	$f_1 = 30MHz, V_{DD} = 100V, I_{DQ} = 250mA, P_{out} = 150W$ Phase Angles	5:1 VSWR - All	No Degradation in Output Power		

1. To MIL-STD-1311 Version A, test method 2204B, Two Tone, Reference Each Tone

Microsemi reserves the right to change, without notice, the specifications and information contained herein.

## Typical Performance Curves

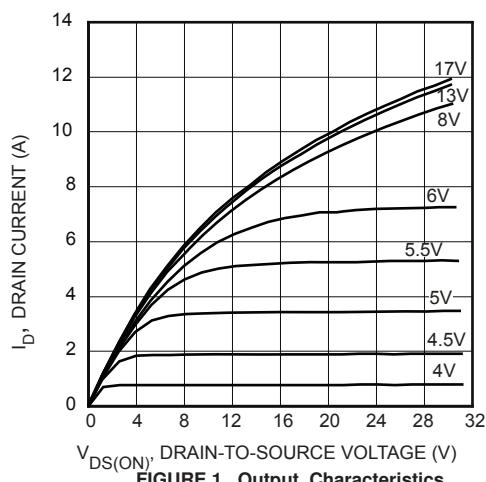


FIGURE 1, Output Characteristics

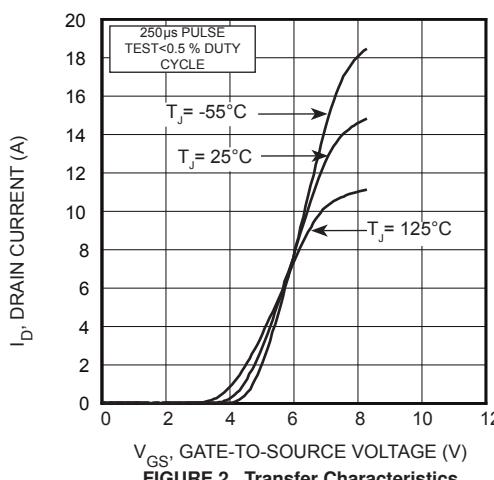


FIGURE 2, Transfer Characteristics

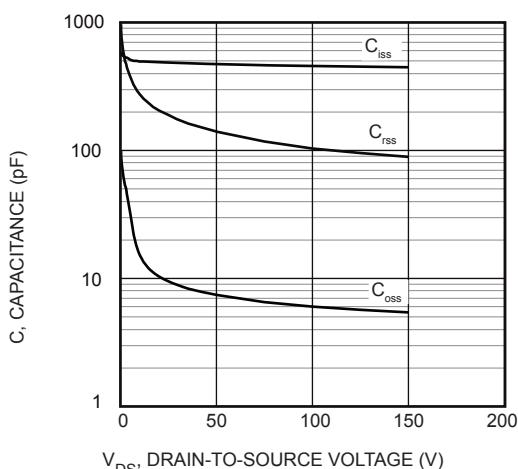


FIGURE 3, Capacitance vs Drain-to-Source Voltage

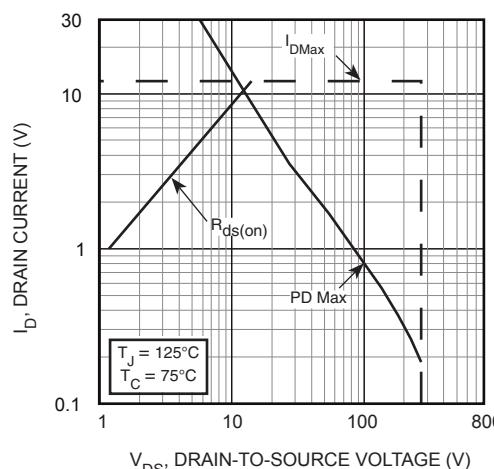


FIGURE 4, Forward Safe Operating Area

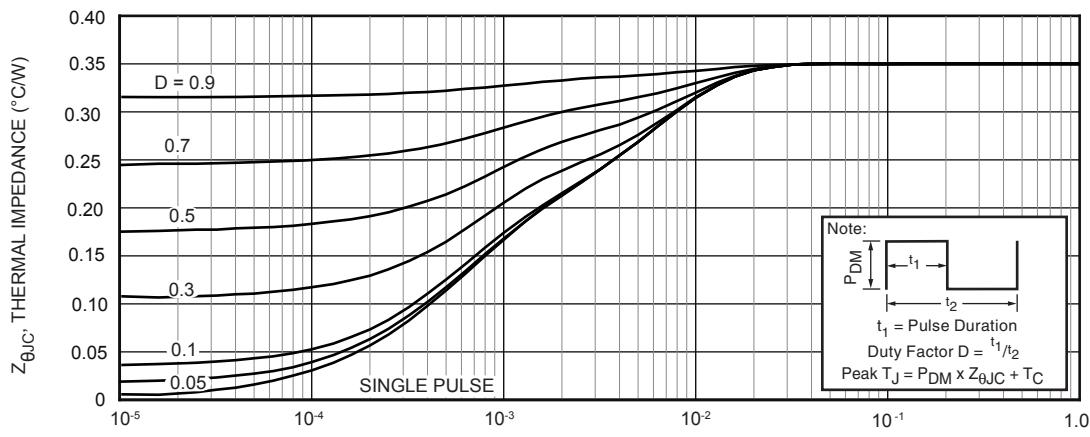
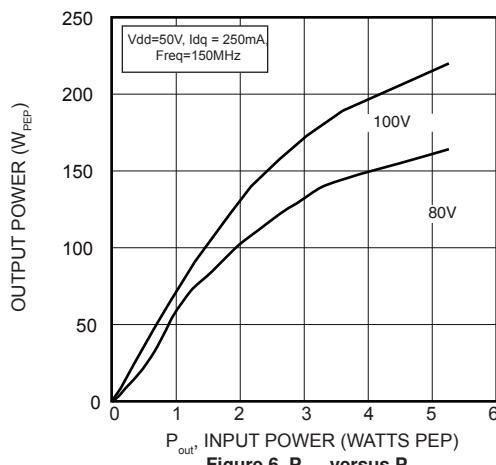
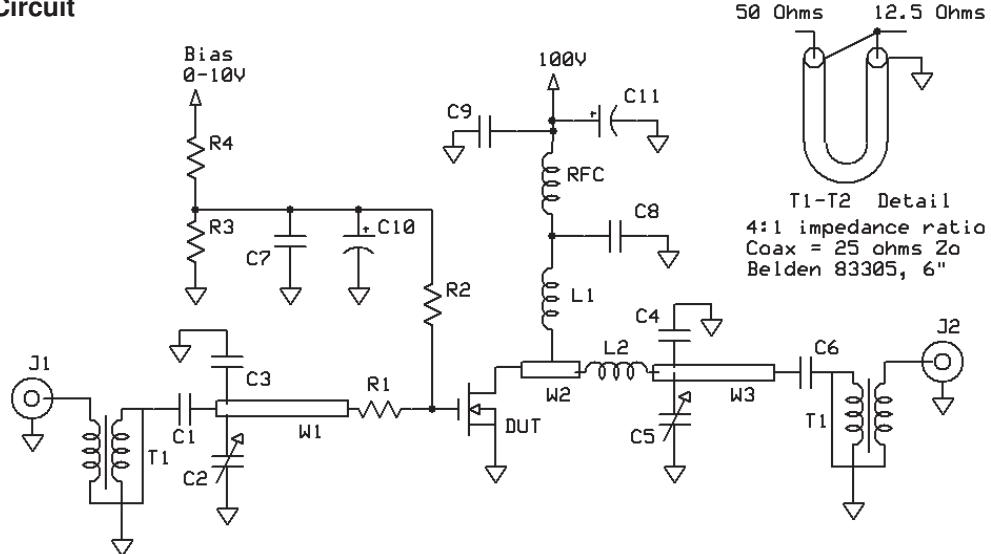


Figure 5. Maximum Effective Transient Thermal Impedance Junction-to-Case vs Pulse Duration

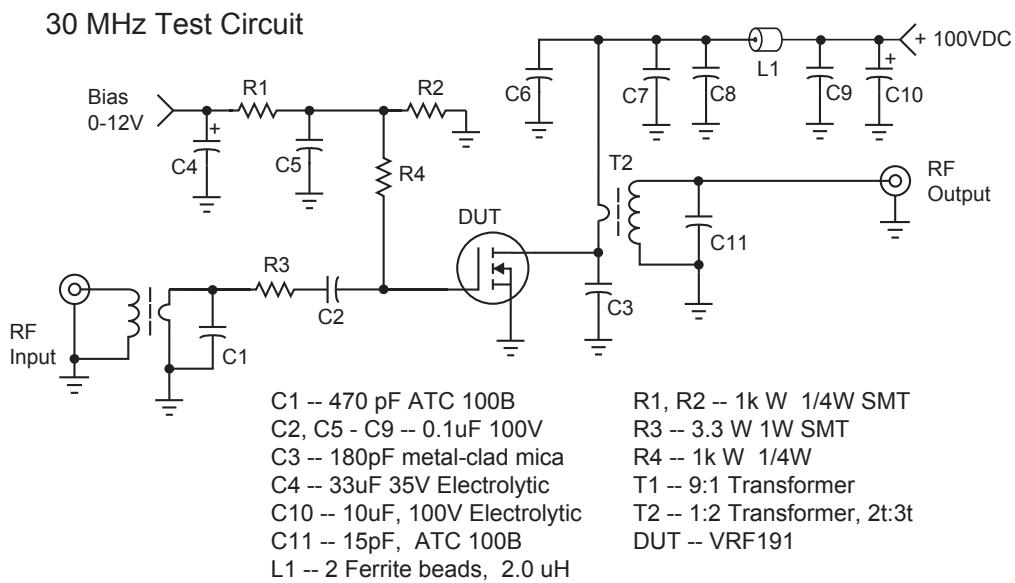
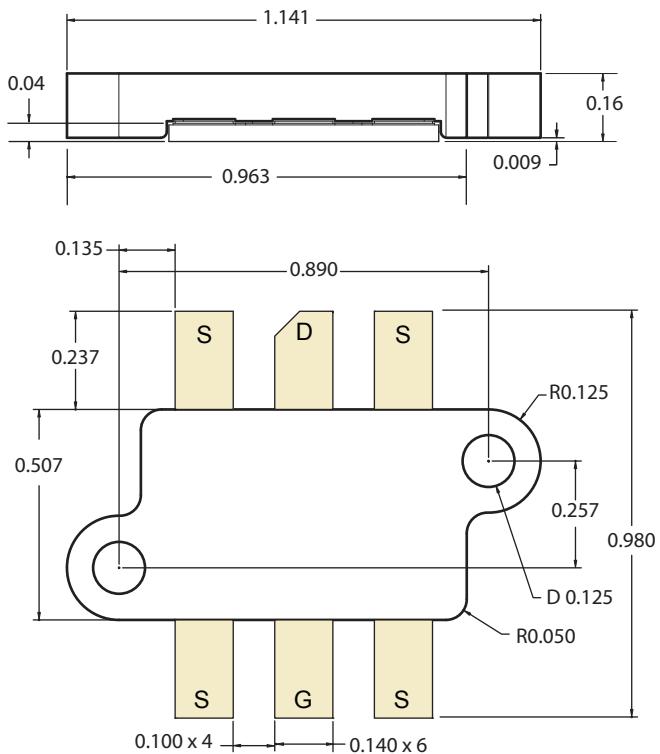
Figure 6.  $P_{out}$  versus  $P_{in}$ 

## 150 MHz Test Circuit



C1, C6 - 910pF ATC 100B  
 C2, C5 - ARCO 406 ~70pF  
 C3 - 110 pF ATC 100B  
 C4 - 120 pF ATC 100B  
 C7-C9 - 0.1uF 100V 1206 SMT  
 C10 - 1 uF 15 WY tant  
 C11 - 15uF 100V Elect  
 L1 - 6t #18 0.25" dia tight  
 L2 - 1.2" #16 into hairpin 18 nH

R1 - 1 ohm 1W SMT  
 R2 - R4 - 2200 ohm 1/4W  
 RFC Fair-Rite 2961666631 (VK200-4B)  
 T1 T2 - 4:1 transformer - see detail  
 W1 Stripline .25 x 1"  
 W2 Stripline .25 x 0.50"  
 W3 Stripline .25" x 75" (30 ohm)  
 DUT - VRF191

**T11 Package Outline**

Microsemi's products are covered by one or more of U.S. patents 4,895,810 5,045,903 5,089,434 5,182,234 5,019,522 5,262,336 6,503,786 5,256,583 4,748,103 5,283,202 5,231,474 5,434,095 5,528,058 6,939,743, 7,352,045 5,283,201 5,801,417 5,648,283 7,196,634 6,664,594 7,157,886 6,939,743 7,342,262 and foreign patents. US and Foreign patents pending. All Rights Reserved.